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| <b>INFORMATION DISCLOSURE<br/>STATEMENT BY APPLICANT</b><br>( Not for submission under 37 CFR 1.99) |  | Application Number     | 10717028                 |
|   |  | Filing Date            | 2003-11-18               |
|   |  | First Named Inventor   | Bo Li                    |
|   |  | Art Unit               | 1795                     |
|   |  | Examiner Name          | Connie P. Johnson        |
|   |  | Attorney Docket Number | H0005567.36146 USA -4780 |

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|                          | 1       | 6056560                              | JP                        | A                      | 1994-03-01       | Sony Corp,                                      |  | <input type="checkbox"/> |
|                          | 2       | 10161315                             | JP                        | A                      | 1998-06-19       | Nippon Steel Chemical Co: Nippon Steel Corp     |  | <input type="checkbox"/> |
|                          | 3       | 59109565                             | JP                        | A                      | 1984-06-25       | Fujitsu Ltd.                                    |  | <input type="checkbox"/> |

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|---|----------|----|---|------------|--------------------|--------------------------|
| 4 | 10502461 | JP | T | 1998-03-03 | Allied Signal Inc. | <input type="checkbox"/> |
| 5 | 9183853  | JP | A | 1997-07-15 | Gen Electric (US)  | <input type="checkbox"/> |
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